

12.1" PCAP Solution 12018290

Date: 2/12/2019



Table of contents

| 1 | Sco | pe | |
|---|-----|--|-----------------------|
| 2 | Tou | ıch Sensor and Cover Glass | |
| | 2.1 | | 3 |
| | 2.2 | | |
| 3 | Tou | ıch Controller (2952T2 USB/l ² C) | 4 |
| | 3.1 | - | |
| | | | |
| | | 3.1.2 Interface specification | |
| | | 3.1.3 Pin Configuration | |
| | 3.2 | 2952T2 I ² C | |
| | | | |
| | | 3.2.2 Interface specification | |
| | | 3.2.3 Pin Configuration | |
| 4 | Opt | tical Inspection Criteria and Hand | Iling Recommendations |
| | 4.1 | - | |
| | 4.2 | | 6 |
| 5 | App | pendix A: Technical Drawing | 7 |
| 6 | Rev | vision History | |



1 Scope

DATA MODUL's PCAP solution 12018290 consists of a 12.1" capacitive touch screen. Please note that this is only a sub-assembly of the final product. The specification of the final end product might differ from this specification.

2 Touch Sensor and Cover Glass

2.1 Technical Parameters

Screen size 12.1 inch /30.7 cm

Format Wide

Composite SITO with COF

Outline dimensions 273.7 x 175.3 x 1.1 mm (WxHxT)

Active area 264.1 x 165.0 mm (WxH)

Bending radius of tail R = 2 mm recommended

Transmissivity 90% (min.)

Operating temperature and humidity -30 to +85°C, < 90% RH Storage temperature and humidity -40 to +95°C, < 80 % RH

Tail connector FPC-Connector (10 pin 0.5mm pitch)

2.2 Reliability Tests

Low Temperature Storage Test -40°C for 480h High Temperature Storage Test 95°C for 480h

High Temperature / High Humidity Test 85°C, 85% RH for 480h

Cycle test -40°C(30min), 85°C(30min), 500cycles

12.1" 12018290 Page 3 / s



3 Touch Controller (2952T2 USB/I²C)

The touch controller IC is provided as a COF (chip on flex) assembly.

3.1 2952T2 USB

3.1.1 Electrical specification

| Power supply | 5V ± 5% |
|-------------------|---|
| Vin ripple | 40 mV peak-peak max. |
| On board voltage | 3.3V and 8.5V max. (subject to configuration) |
| Power consumption | 400 mW max. (subject to configuration) |

3.1.2 Interface specification

| Protocol | USB 2.0 | |
|------------------------|---|--|
| | HID specification 1.11 with amendments for multitouch digitizer | |
| Endpoint Address | 0x81(Endpoint 1) | |
| | 0x02(Endpoint 2) | |
| | 0x83(Endpoint 3) | |
| Touch report | 16 fingers simultaneously max. | |
| Resolution | 4096 x 4096 (x/y) | |
| vendor ID / product ID | 0x03EB (Atmel) / 0x214E (mXT2952T2) | |
| Bus speed | 12 Mbps max. (subject to configuration) | |

3.1.3 Pin Configuration

| Pin | Signal | Description |
|-----|--------|--------------------------|
| 1 | VDD | Power Supply |
| 2 | - | Pull up to VddIO |
| 3 | - | Pull up to VddIO |
| 4 | - | Pull up to VDD |
| 5 | RES | Reset, active low |
| 6 | USBDM | USB data minus |
| 7 | USBDP | USB data plus |
| 8 | CSEL | Connect to VddIO for USB |
| 9 | - | Do not connect |
| 10 | GND | Ground |

12.1" 12018290 Page 4/5



3.2 2952T2 I²C

3.2.1 Electrical specification

| Power supply | 3.3V ± 5% |
|-------------------|--|
| Vin ripple | 40 mV peak-peak max. |
| On board voltage | 3.3 and 9V max. (subject to configuration) |
| Power consumption | 400 mW max. (subject to configuration) |
| | |

3.2.2 Interface specification

| Protocol | I ² C version 6.0 | | |
|---|---|---|--|
| Touch report | 16 fingers simultaneously max. | | |
| Resolution | 4096 x 4096 (x/y) | | |
| I ² C address | 0x4A or 0x4B | | |
| HID-I ² C vendor ID / product ID | 0x03EB (Atmel) / 0x214E (mXT2952T2) | | |
| Required pull-up resistance | Standard mode (100 kHz) Fast mode (400 kHz) Fast+ mode (1 MHz) High-Speed mode (3.4 MHz) | 1k to 10k 1k to 3k 0.7k max. 0.5k to 0.75k | |
| Low input logic level | SDA, SCL RES, GPIO | -0.3V to 0.3x VddIO | |
| High input logic level | SDA, SCL RES, GPIO | 0.7 x VddIO to VddIO 0.85 VddIO to VddIO | |
| Low output logic level | CHG, GPIO | 0V to 0.2 x VddIO | |
| High output logic level | CHG, GPIO | 0.8 x VddIO to VddIO | |

3.2.3 Pin Configuration

| Pin | Signal | Description |
|-----|-------------------|---|
| 1 | VDD | Power Supply |
| 2 | CHG | Change Interrupt, active low, need Pull Up |
| 3 | SDA | I ² C Data, need Pull Up |
| 4 | SCL | I ² C Clock, need Pull Up |
| 5 | RES | Reset, active low |
| 6 | - | Do not connect |
| 7 | ADDSEL | Pulled down by 15K Ohm, Pull up for 0x4B leave unconnected for 0x4A |
| 8 | CSEL | Connect to Ground for I ² C |
| 9 | I ² CM | I ² C mode selection, low to select HID-I ² C mode, high to select I ² C mode, floating for automatic mode selection |
| 10 | GND | Ground |

12.1" 12018290 Page 5 / s



4 Optical Inspection Criteria and Handling Recommendations

4.1 Optical Inspection Criteria

For details on the optical inspection criteria, please refer to DATA MODULs Outgoing Spec or ask your local DATA MODUL sales representative.

4.2 Handling Recommendations

Precautions for operation

- Do not put a heavy, hard or sharp object on the product
- Do not bend the product in order to assure the reliability
- Do not put one product on the other. Otherwise, it may cause the product to be scratched
- Don't use any organic solvent acid or alkali solution.

Precautions for mounting

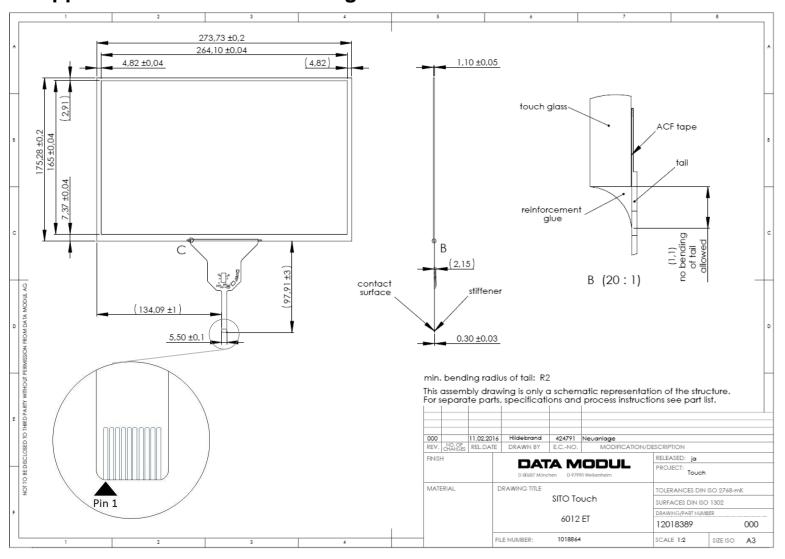
- The panel should be mounted using a configuration that either holds the panel by all four corners or by all four sides
- The bezel edge must be positioned outside the active area. The bezel may cause false activation if the edge overlaps the active area
- Any mounting configuration should ensure that there is no twisting force applied to the panel
- 1mm distance between TFT screen and touch panel is recommended

Precautions for tail

- The flex tail in general can be bent with a min. radius of about 1mm
- In order to avoid damaging and malfunction of the sensor, please don't bend the FPC area next to the panel
- Excess or repeated bending of the FPC connector should also be avoided

DATA MODUL

5 Appendix A: Technical Drawing



12.1" 12018290 Page 7 / 9

DATA MODUL

6 Revision History

| Date | Author | Changes |
|-----------|------------|-----------------|
| 2/12/2019 | T. Golling | initial version |
| | | |
| | | |
| | | |

12.1" 12018290 Page 8 / 9

DATA MODUL

DATA MODUL Aktiengesellschaft

Landsberger Str. 322 80687 Munich, Germany Tel. +49-89-5 60 17-0 Fax +49-89-5 60 17-119 www.data-modul.com

Logistics, Production & Services:

DATA MODUL Weikersheim GmbH Lindenstrasse 8 DE-97990 Weikersheim - Germany

Phone: +49-7934-101-0 Fax: +49-7934-101-101

DATA MODUL's worldwide offices

can be found on our website: www.data-modul.com/eu/contact-worldwide.html



12.1" 12018290 Page 9/9